NEWS RELEASE

Hamamatsu Photonics will construct a new factory Building No. 14 at the main factory site to boost production capacity to meet increased demand for opto-semiconductors.

June 25, 2018
Hamamatsu Photonics K. K.
Headquarters: 325-6, Sunayama-cho,
Naka-ku, Hamamatsu City, Japan
President and CEO: Akira Hiruma

Hamamatsu Photonics will construct a new factory Building No. 14 at the main factory site (Ichino-cho, Higashi-ku, Hamamatsu City, Japan) to meet growing sales demand for its opto-semiconductor module products.

The groundbreaking ceremony for the new factory building is scheduled to be held on June 26, 2018, and the new factory building will be completed in July 2019.

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Hamamatsu Photonics has been supplying opto-semiconductors and module products that combine opto-semiconductors with electronic circuits, optical components and software for a wide variety of fields such as medical diagnosis and treatment, scientific measurements, and automobiles. Recently, there has been vastly increasing demand for opto-semiconductor module products that can easily be assembled directly into equipment that customers manufacture. This means that here at Hamamatsu Photonics we can expect a steady increase in sales of opto-semiconductor products including MPPC® (Multi-Pixel Photon Counter) modules for medical imaging devices, mini-spectrometers and optics modules for industrial equipment, and opto-semiconductor module products for automobiles.

In the new factory building, along with consolidating our design & development departments for opto-semiconductor module products, which are currently dispersed in different locations at our main factory site, we will combine, consolidate and expand production space to enhance the development speed and production capacity of our opto-semiconductor module products. We will also transfer our product warehouse and shipping functions to the new factory building so that all logistics functions including receipt of orders, procurement, warehouse operation and shipping will be clustered together within the main factory site. This will help us improve business operational efficiency, information sharing and customer response speed. We also plan to boost production capacity of other opto-semiconductors such as image sensors, since free space available in existing factory buildings after clustering departments together in the new

factory building will be utilized as space for production processes.

Based on our business continuity plan, this new factory building is designed with stronger disaster countermeasures that incorporate earthquake measures and flood measures such as waterproof doors, as well as environmental measures including installation of LED lighting, heat-insulating structures, and solar panels.

The groundbreaking ceremony and details about the new factory building are as follows:

<Groundbreaking Ceremony>

Ceremony name: Groundbreaking ceremony for Building No. 14 at the main factory of Hamamatsu Photonics K.K.

Date: June 26 (Tuesday) 2018, 10:00 A.M.

Location: 1126-1, Ichino-cho, Higashi-ku, Hamamatsu City, Shizuoka Pref., Japan
Planned construction site to the westward side of Building No. 7 at the main factory site

<New Factory Building Overview>

Building name: Building No. 14 of main factory

Location: 1126-1, Ichino-cho, Higashi-ku, Hamamatsu City, Shizuoka Pref., Japan

Construction period:
Scheduled to start in June 2018 and be completed in July 2019

Operation start date:
October 2019

Building structure: Steel frame construction, 4 floors above ground, 1 floor underground

Building size: Building area: 2,441 square meters,
total floor area: 9,857 square meters

Facility layout:

Underground	Warehouse
1st floor	Distribution area, product warehouse, reception area
2nd floor	Production of opto-semiconductor module products, offices
3rd floor	Production of opto-semiconductor module products
4th floor	Design and evaluation of opto-semiconductor module products,design rooms, conference rooms, rest area/lounge

Total construction cost:
Approximately 2.8 billion yen

Seating capacity: Approximately 240

Products: Opto-semiconductor module products

Production capacity:
Approximately 10 billion yen annually (converted to sales figure)

Artist’s rendering of Building No. 14 at our main factory